

Title (en)

Packaging element comprising a tray with openings and an edge flange for pipette tips intended to be placed in an autoclave.

Title (de)

Verpackungseinheit für mit Pipettenspitzen bestückten, zum Einsatz in autoklavierbaren Behältern bestimmten, einen Randflansch aufweisenden Lochplatten.

Title (fr)

Élément d'emballage comprenant un plateau muni d'ouvertures ainsi qu'une bride pour pointes de pipettes, prévu pour être inséré dans un autoclave.

Publication

**EP 0628484 A3 19950614 (DE)**

Application

**EP 94108805 A 19940608**

Priority

DE 4318876 A 19930608

Abstract (en)

[origin: EP0628484A2] 1. A packaging element for trays having openings and an edge flange and fitted with pipette tips intended to be placed in an autoclave, consisting of a cardboard wrapping which encloses the trays and has a hinged lid, in which packaging the trays are provided with a peripheral edge flange (8) and the cardboard wrapping (4) is provided with a hinged lid (5, 6) disposed on the top side and on the underside, the cardboard wrapping having a height which corresponds approximately to the length of a pipette tip plus the thickness of a tray, and a spacer frame being provided in the cardboard wrapping, which frame serves to place the trays (2) on and has a length and width falling slightly below the corresponding internal dimensions of the edge flange (8) of the trays (2) and such a height that the unit formed from a spacer frame and trays (2) placed on both sides has a height which corresponds to the height of the cardboard wrapping. The lid flaps are attached to two diagonally opposite edges of the cardboard wrapping, the walls (10) of the cardboard wrapping bearing the lid flaps (5, 6) having a height which is reduced by the height of one tray and being provided on the attachment edge with a finger-hole cutout. <IMAGE>

IPC 1-7

**B65D 5/50**; **B65D 85/42**

IPC 8 full level

**B01L 9/00** (2006.01); **B65D 5/50** (2006.01); **B65D 85/42** (2006.01)

CPC (source: EP)

**B01L 9/543** (2013.01); **B65D 5/50** (2013.01); **B65D 85/42** (2013.01)

Citation (search report)

- [XA] DE 9203565 U1 19920507
- [PA] US 5318753 A 19940607 - HONDA HISASHI [JP]
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